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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

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 ) envelope addressed to:  
Title: Methods of Forming Metal )  
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Lines in Semiconductor Devices ) Mail Stop Amendment  
 ) Commissioner for Patents  
Filed: December 30, 2003 ) P.O. Box 1450  
 ) Alexandria, VA 22313-1450  
TC/AU: 2891 ) on this date:  
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Examiner: Lee, Granvill ) Dated: 7/14/2005  
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 ) Mark C. Zimmerman  
 ) Registration No. 44,006

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

RESPONSE TO THE OFFICE ACTION DATED APRIL 15, 2005

Dear Sir:

Please enter the following amendments and consider the following remarks.

**The Status of the Claims** is reflected in the listing of claims that begins on page 2 of this paper.

**Remarks begin on page 5 of this paper.**